

FINAL PRODUCT/PROCESS CHANGE NOTIFICATION #16441D

Generic Copy

Issue Date: 19-Apr-2013

TITLE: NCP1403 Qualification at Gresham Wafer Fab

PROPOSED FIRST SHIP DATE: 19-Jul-2013

AFFECTED CHANGE CATEGORY(S): Wafer Fab

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or <mathew.hilton@onsemi.com>

SAMPLES: Contact your local ON Semiconductor Sales Office

ADDITIONAL RELIABILITY DATA: Available

Contact your local ON Semiconductor Sales Office or <edmond.gallard@onsemi.com>

NOTIFICATION TYPE:

Final Product/Process Change Notification (FPCN)

Final change notification sent to customers. FPCNs are issued at least 90 days prior to implementation of the change.

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact <quality@onsemi.com>.

DESCRIPTION AND PURPOSE:

ON Semiconductor is pleased to announce a capacity expansion qualification for the NCP1403 product.

This device is currently qualified at ON Semiconductor's Aizu wafer fab facility located in Aizu, Japan and is now qualified at ON Semiconductor's Gresham wafer fabrication facility located in Gresham, Oregon. Upon expiration (or approval) of this Final PCN, devices may be supplied by either wafer fab.

The Gresham wafer fab is compliant to ISO9001:2008, ISO/TS16949:2009, and ISO14001:2004. The NCP1403 currently runs on the Aizu ACMOS1 process. The same ACMOS1 process has been transferred to and successfully qualified at the Gresham wafer fab. No device design changes have been made. The NCP1403 will continue to be assembled and tested in existing qualified locations. No changes to packaging will occur as a result of this fab qualification.

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RELIABILITY DATA SUMMARY:

Platform Reliability Test Results:

The Gresham-sourced NCP1403 has been qualified based on the successful platform qual of the ACMOS1 technology in Gresham with qual vehicles: NCP305, NCP551, NCP2860, and NCS2002.

Test	Conditions	Results
High Temp Op Life NCP304 NCP551 NCP2860 NCS2002	Ta=+125C, 1008 hours	0/80 (1 lot) 0/80 (1 lot) 0/80 (3 lots) 0/80 (1 lot)
Early Life Failure Rate NCP304 NCP551 NCS2002	Ta=+125C, 48 hours	0/800 (1 lot) 0/800 (1 lot) 0/800 (1 lot)
Highly Accelerated Stress NCP304 NCP551 NCS2002	Ta=131C/85% RH, 96 hours w/MSL1 pre-conditioning	0/80 (1 lot) 0/80 (1 lot) 0/80 (1 lot)
Unbiased Highly Accel. Stress NCP304 NCP551 NCP2860 NCS2002	Ta=131C/85% RH, 96 hours w/MSL1 pre-conditioning	0/80 (1 lot) 0/80 (1 lot) 0/80 (3 lots) 0/80 (1 lot)
Temperature Cycle NCP304 NCP551 NCP2860 NCS2002	-65C to +150C, 500 cycles	0/80 (1 lot) 0/80 (1 lot) 0/80 (3 lots) 0/80 (1 lot)
Scan. Acoustical Tomography NCP304 NCP551 NCP2860 NCS2002	MSL1	0/5 (1 lot) 0/5 (1 lot) 0/5 (3 lots) 0/5 (1 lot)
ESD	Human Body Model Machine Model	Pass 2000V (NCP304) Pass 200V (NCP304)
Latch Up	JEDEC JESD78	Pass 500mA Pos / 170mA Neg (NCP305)

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NCP1403 Reliability Test Results:

The Gresham-sourced NCP1403 has had the following reliability tests performed.

Test	Conditions	Results
Latch Up	JEDEC JESD78	Pass +-150mA
ESD	Human Body Model	Pass 2000V for all pins except LX Pass 1500V for LX pin
	Machine Model	Pass 200V

ELECTRICAL CHARACTERISTIC SUMMARY:

Electrical characterization has been completed on the Gresham NCP1403 material with no changes to the AC/DC specifications.

ON Semiconductor recommends samples be obtained for application specific review. Data is available upon request.

CHANGED PART IDENTIFICATION:

Devices with date codes of 2013 work week 28 or later may be sourced from either wafer fab.

List of affected General Parts:

NCP1403SNT1G

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